



## N-Channel Logic Level Enhancement Mode Field Effect Transistor

### PRODUCT SUMMARY

| VDSS | ID  | RDS(ON) (mΩ) Max |
|------|-----|------------------|
| 40V  | 60A | 9 @ VGS=10V      |
|      |     | 10 @ VGS=4.5V    |

### FEATURES

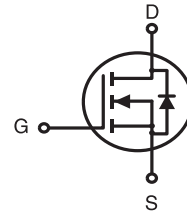
- Super high dense cell design for extremely low RDS(ON).
- High power and current handling capability.
- TO-220 & TO-263 package.



STB SERIES  
TO-263(DD-PAK)



STP SERIES  
TO-220



### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C unless otherwise noted)

| Symbol                            | Parameter                                        | Limit                                                    | Units  |
|-----------------------------------|--------------------------------------------------|----------------------------------------------------------|--------|
| V <sub>DS</sub>                   | Drain-Source Voltage                             | 40                                                       | V      |
| V <sub>GS</sub>                   | Gate-Source Voltage                              | ±20                                                      | V      |
| I <sub>D</sub>                    | Drain Current-Continuous <sup>a</sup>            | T <sub>A</sub> =25°C<br>60<br>T <sub>A</sub> =70°C<br>50 | A<br>A |
| I <sub>DM</sub>                   | -Pulsed <sup>b</sup>                             | 240                                                      | A      |
| E <sub>AS</sub>                   | Avalanche Energy <sup>c</sup>                    | 196                                                      | mJ     |
| P <sub>D</sub>                    | Maximum Power Dissipation <sup>a</sup>           | T <sub>A</sub> =25°C<br>70<br>T <sub>A</sub> =70°C<br>45 | W<br>W |
| T <sub>J</sub> , T <sub>STG</sub> | Operating Junction and Storage Temperature Range | -55 to 150                                               | °C     |

### THERMAL CHARACTERISTICS

|                  |                                         |     |      |
|------------------|-----------------------------------------|-----|------|
| R <sub>θJC</sub> | Thermal Resistance, Junction-to-Case    | 1.8 | °C/W |
| R <sub>θJA</sub> | Thermal Resistance, Junction-to-Ambient | 50  | °C/W |

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## ELECTRICAL CHARACTERISTICS (T<sub>C</sub>=25°C unless otherwise noted)

| Symbol                                                                               | Parameter                                             | Conditions                                                                                    | Min | Typ   | Max  | Units |
|--------------------------------------------------------------------------------------|-------------------------------------------------------|-----------------------------------------------------------------------------------------------|-----|-------|------|-------|
| OFF CHARACTERISTICS                                                                  |                                                       |                                                                                               |     |       |      |       |
| BV <sub>DSS</sub>                                                                    | Drain-Source Breakdown Voltage                        | V <sub>GS</sub> =0V , I <sub>D</sub> =250uA                                                   | 40  |       |      | V     |
| I <sub>DSS</sub>                                                                     | Zero Gate Voltage Drain Current                       | V <sub>DS</sub> =32V , V <sub>GS</sub> =0V                                                    |     |       | 1    | A     |
| I <sub>GSS</sub>                                                                     | Gate-Body leakage current                             | V <sub>GS</sub> = ±20V , V <sub>DS</sub> =0V                                                  |     |       | ±100 | nA    |
| ON CHARACTERISTICS <sup>a</sup>                                                      |                                                       |                                                                                               |     |       |      |       |
| V <sub>GS(th)</sub>                                                                  | Gate Threshold Voltage                                | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA                                      | 1   | 1.6   | 3    | V     |
| R <sub>DS(ON)</sub>                                                                  | Drain-Source On-State Resistance                      | V <sub>GS</sub> =10V , I <sub>D</sub> =20A                                                    |     | 7     | 9    | m ohm |
|                                                                                      |                                                       | V <sub>GS</sub> =4.5V , I <sub>D</sub> =12A                                                   |     | 8.5   | 10   | m ohm |
| g <sub>FS</sub>                                                                      | Forward Transconductance                              | V <sub>DS</sub> =10V , I <sub>D</sub> =20A                                                    |     | 28.1  |      | S     |
| DYNAMIC CHARACTERISTICS <sup>b</sup>                                                 |                                                       |                                                                                               |     |       |      |       |
| C <sub>ISS</sub>                                                                     | Input Capacitance                                     | V <sub>DS</sub> =20V,V <sub>GS</sub> =0V<br>f=1.0MHz                                          |     | 1360  |      | pF    |
| C <sub>OSS</sub>                                                                     | Output Capacitance                                    |                                                                                               |     | 248.5 |      | pF    |
| C <sub>RSS</sub>                                                                     | Reverse Transfer Capacitance                          |                                                                                               |     | 143   |      | pF    |
| SWITCHING CHARACTERISTICS <sup>b</sup>                                               |                                                       |                                                                                               |     |       |      |       |
| t <sub>D(ON)</sub>                                                                   | Turn-On DelayTime                                     | V <sub>DD</sub> =20V<br>I <sub>D</sub> =1A<br>V <sub>GS</sub> =10V<br>R <sub>GEN</sub> =6 ohm |     | 24    |      | ns    |
| t <sub>r</sub>                                                                       | Rise Time                                             |                                                                                               |     | 25    |      | ns    |
| t <sub>D(OFF)</sub>                                                                  | Turn-Off DelayTime                                    |                                                                                               |     | 67    |      | ns    |
| t <sub>f</sub>                                                                       | Fall Time                                             |                                                                                               |     | 32    |      | ns    |
| Q <sub>g</sub>                                                                       | Total Gate Charge                                     | V <sub>DS</sub> =20V,I <sub>D</sub> =20A,V <sub>GS</sub> =10V                                 |     | 26    |      | nC    |
|                                                                                      |                                                       | V <sub>DS</sub> =20V,I <sub>D</sub> =20A,V <sub>GS</sub> =4.5V                                |     | 12.5  |      | nC    |
| Q <sub>gs</sub>                                                                      | Gate-Source Charge                                    | V <sub>DS</sub> =20V,I <sub>D</sub> =20A,<br>V <sub>GS</sub> =10V                             |     | 2.8   |      | nC    |
| Q <sub>gd</sub>                                                                      | Gate-Drain Charge                                     |                                                                                               |     | 6     |      | nC    |
| DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS                               |                                                       |                                                                                               |     |       |      |       |
| I <sub>S</sub>                                                                       | Maximum Continuous Drain-Source Diode Forward Current |                                                                                               |     |       | 2    | A     |
| V <sub>SD</sub>                                                                      | Diode Forward Voltage                                 | V <sub>GS</sub> =0V,I <sub>S</sub> =2A                                                        |     | 0.74  | 1.3  | V     |
| Notes                                                                                |                                                       |                                                                                               |     |       |      |       |
| a.Pulse Test:Pulse Width ≤ 300us, Duty Ctle ≤ 2%.                                    |                                                       |                                                                                               |     |       |      |       |
| b.Guaranteed by design, not subject to production testing.                           |                                                       |                                                                                               |     |       |      |       |
| c.Starting T <sub>J</sub> =25°C,VDD=40V, V <sub>GS</sub> =10V,L=0.5mH.(See Figure13) |                                                       |                                                                                               |     |       |      |       |

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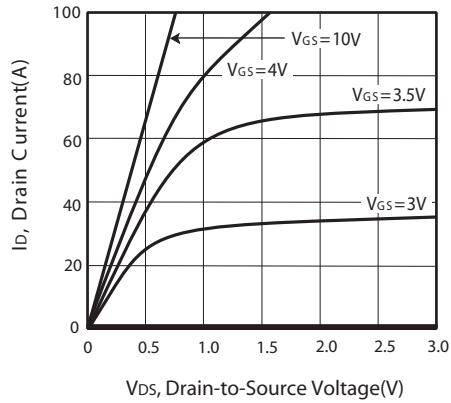


Figure 1. Output Characteristics

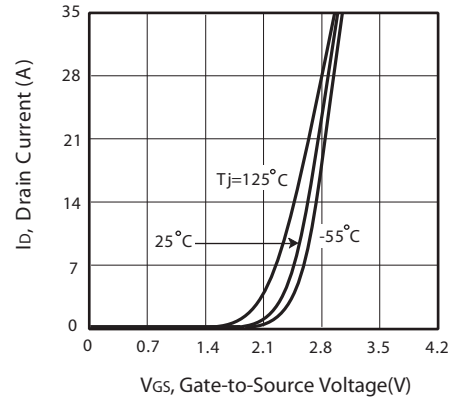


Figure 2. Transfer Characteristics

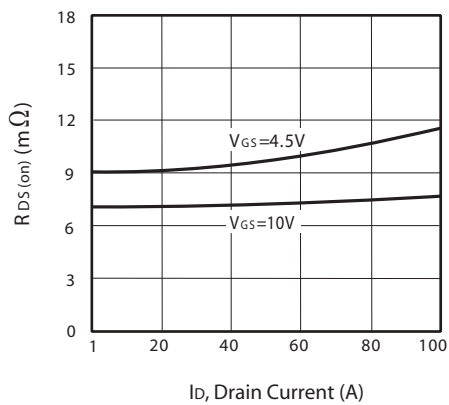


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

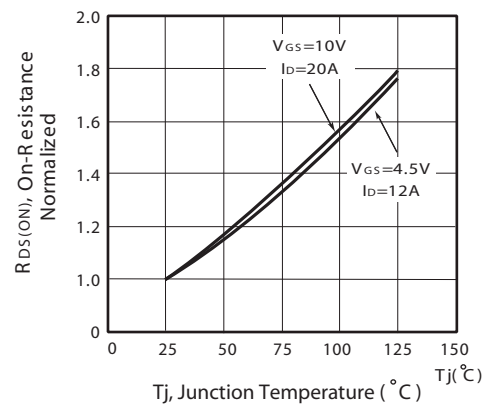


Figure 4. On-Resistance Variation with Drain Current and Temperature

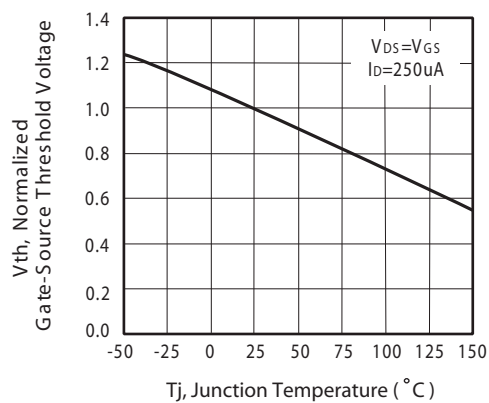


Figure 5. Gate Threshold Variation with Temperature

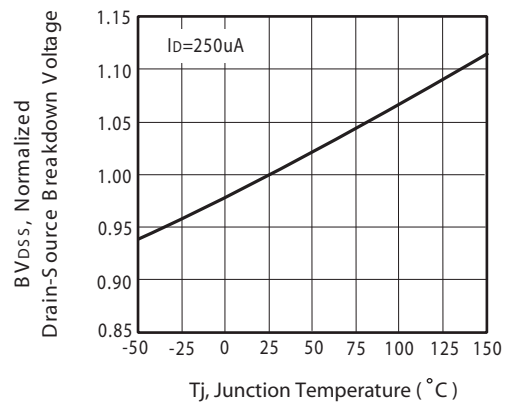


Figure 6. Breakdown Voltage Variation with Temperature

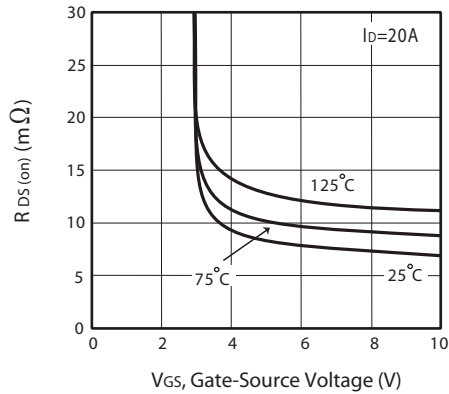


Figure 7. On-Resistance vs. Gate-Source Voltage

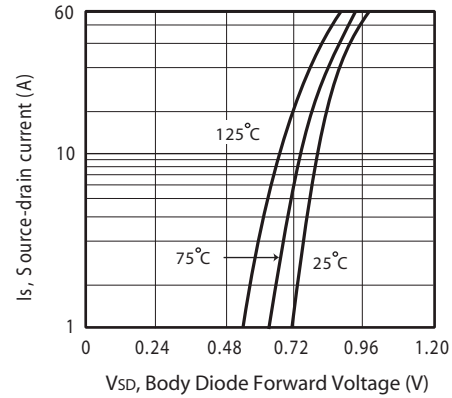


Figure 8. Body Diode Forward Voltage Variation with Source Current

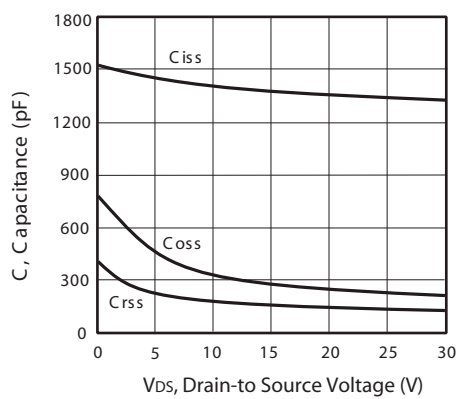


Figure 9. Capacitance

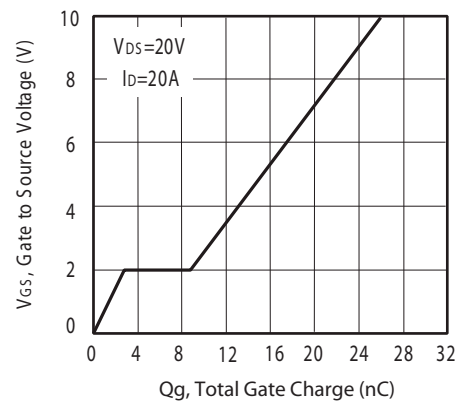


Figure 10. Gate Charge

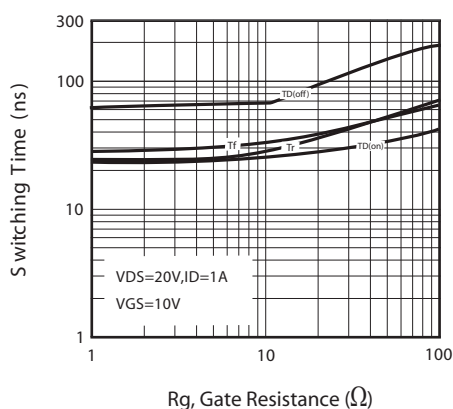


Figure 11. Switching Characteristics

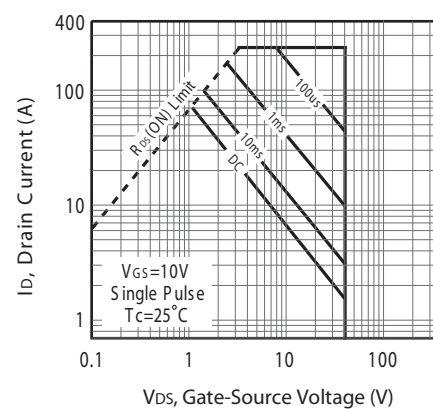
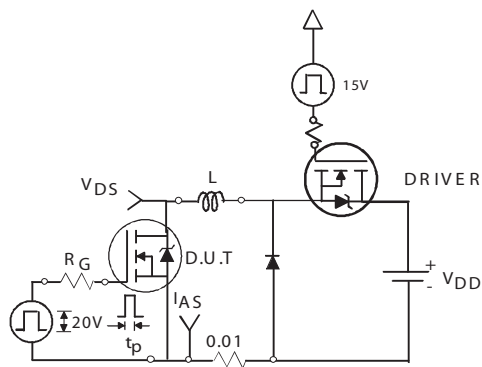
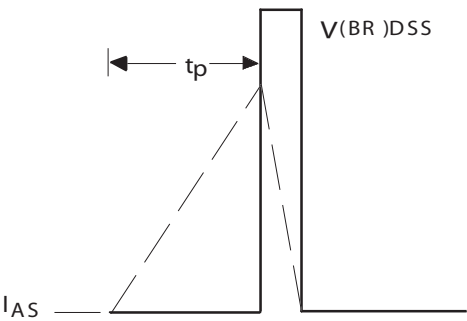


Figure 12. Maximum Safe Operating Area



Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

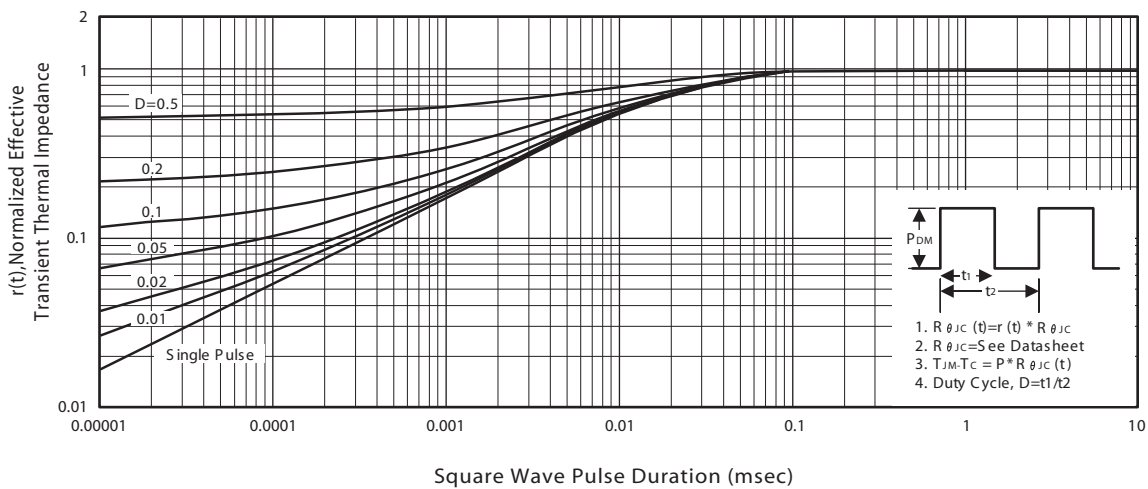


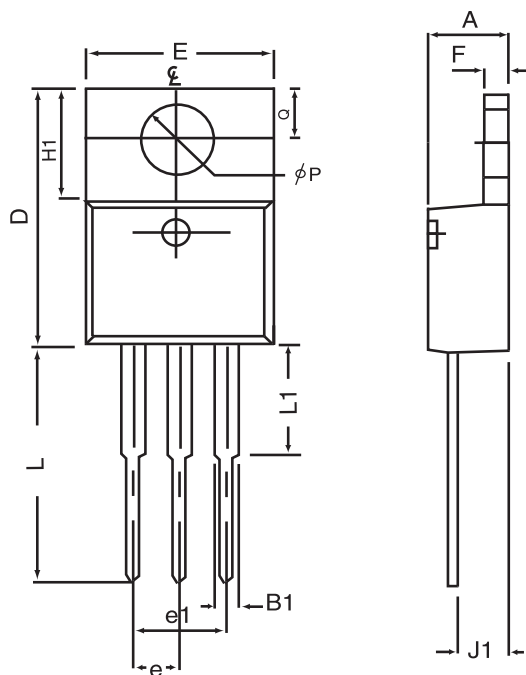
Figure 14. Normalized Thermal Transient Impedance Curve

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## PACKAGE OUTLINE DIMENSIONS

### TO-220

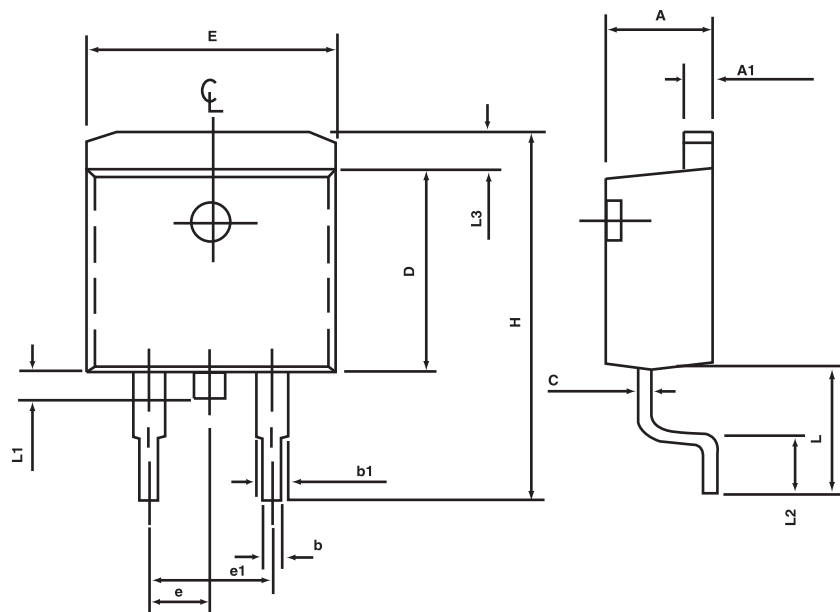


| SYMBOLS | MILLIMETERS |       | INCHES |       |
|---------|-------------|-------|--------|-------|
|         | MIN         | MAX   | MIN    | MAX   |
| A       | 4.32        | 4.80  | 0.170  | 0.189 |
| B1      | 1.27        | 1.65  | 0.050  | 0.630 |
| D       | 14.6        | 16.00 | 0.575  | 0.610 |
| E       | 9.70        | 10.41 | 0.382  | 0.410 |
| e       | 2.34        | 2.74  | 0.092  | 0.108 |
| e1      | 4.68        | 5.48  | 0.184  | 0.216 |
| F       | 1.14        | 1.40  | 0.045  | 0.055 |
| H1      | 5.97        | 6.73  | 0.235  | 0.265 |
| J1      | 2.20        | 2.79  | 0.087  | 0.110 |
| L       | 12.88       | 14.22 | 0.507  | 0.560 |
| L1      | 3.00        | 6.35  | 0.120  | 0.250 |
| φP      | 3.50        | 3.94  | 0.138  | 0.155 |
| Q       | 2.54        | 3.05  | 0.100  | 0.120 |

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## PACKAGE OUTLINE DIMENSIONS

### TO-263AB

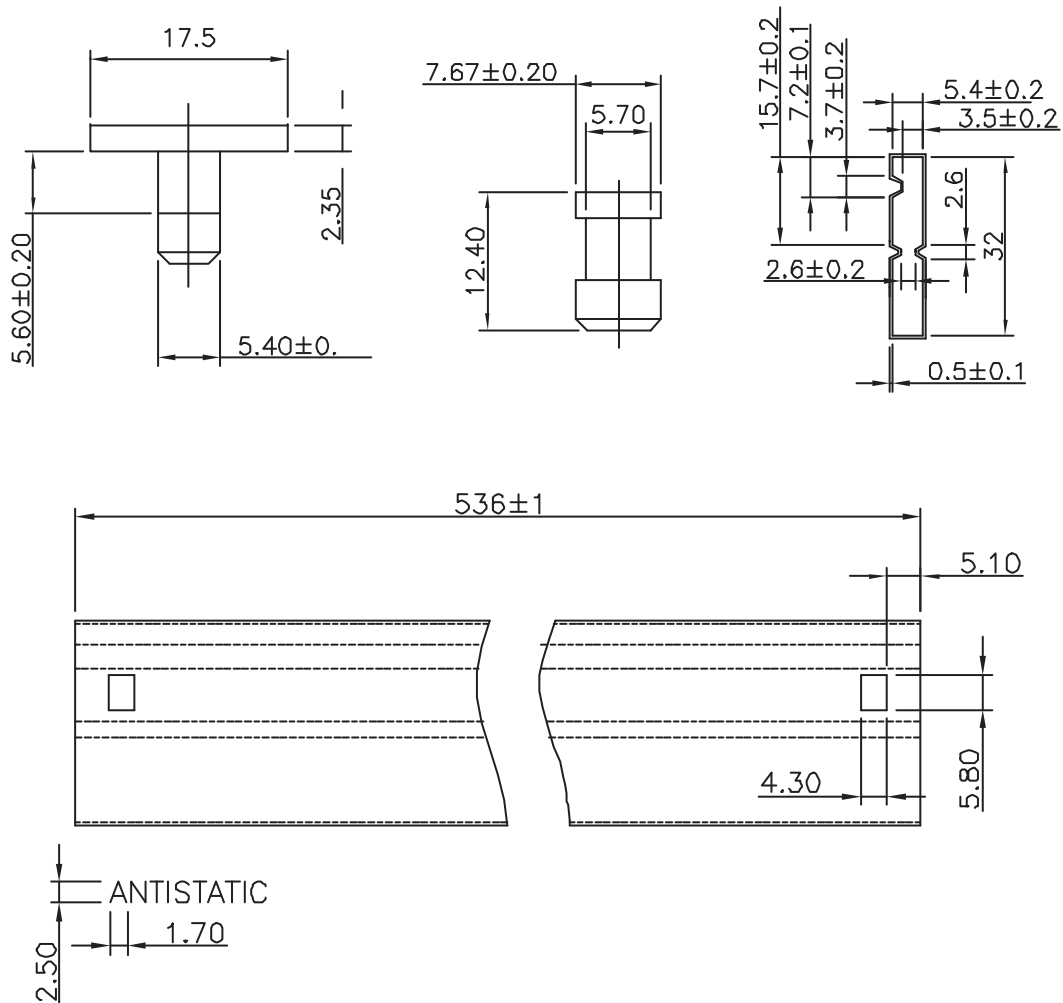


| SYMBOLS | MILLIMETERS |       | INCHES    |       |
|---------|-------------|-------|-----------|-------|
|         | MIN         | MAX   | MIN       | MAX   |
| A       | 4.30        | 4.70  | 0.169     | 0.185 |
| A1      | 1.22        | 1.32  | 0.048     | 0.055 |
| b       | 0.69        | 0.94  | 0.027     | 0.037 |
| b1      | 1.22        | 1.40  | 0.048     | 0.055 |
| C       | 0.36        | 0.56  | 0.014     | 0.022 |
| D       | 8.64        | 9.652 | 0.340     | 0.380 |
| E       | 9.70        | 10.54 | 0.382     | 0.415 |
| e       | 2.29        | 2.79  | 0.090     | 0.110 |
| e1      | 4.83        | 5.33  | 0.190     | 0.210 |
| H       | 14.60       | 15.78 | 0.575     | 0.625 |
| L       | 4.70        | 5.84  | 0.185     | 0.230 |
| L1      | 1.20        | 1.778 | 0.047     | 0.070 |
| L2      | 2.24        | 2.84  | 0.088     | 0.111 |
| L3      | 1.40 MAX    |       | 0.055 MAX |       |

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## TO-220/263AB Tube



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